505716773 10/10/2019

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5763584

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HIROAKI ITO	09/05/2019
TAKANORI OZAWA	09/05/2019

RECEIVING PARTY DATA

Name:	ROHM CO., LTD.
Street Address:	21, SAIIN MIZOSAKI-CHO
Internal Address:	UKYO-KU
City:	KYOTO-SHI, KYOTO
State/Country:	JAPAN
Postal Code:	6158585

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16524426

CORRESPONDENCE DATA

Fax Number: (312)803-4960

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email: docketing@chiplawgroup.com

Correspondent Name: CHIP LAW GROUP

Address Line 1: 505 N LAKESHORE DR

Address Line 2: SUITE 250

Address Line 4: CHICAGO, ILLINOIS 60611

ATTORNEY DOCKET NUMBER:	19ROH012US0	
NAME OF SUBMITTER:	PRAMOD CHINTALAPOODI	
SIGNATURE:	/Pramod Chintalapoodi/	
DATE SIGNED:	10/10/2019	

Total Attachments: 2

source=19ROH012US0_DecAssign#page1.tif source=19ROH012US0_DecAssign#page2.tif

PATENT 505716773 REEL: 050676 FRAME: 0690

Attorney Docket No. 19ROH012U50 Client Docket No. 18-00117US01

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE

Title of SEMICONDUCTOR DEVICE Invention			
As the below named inventor, I hereby declare that:			
This declaration The attached application, or			
is directed to: 🗵 United States application or PCT international application number 16/524,426 filed on July 29, 2019			
The above-identified application was made or authorized to be made by me.			
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.			
WHEREAS, ROHM Co., LTD.			
(hereinafter referred to as "ASSIGNEE") having places of business at: 21, Saiin Mizosaki-cho, Ukyo-ku, Kyoto-shi,			
Kyoto, Japan is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;			
NOW, THEREFORE, in consideration of the sum of ONE DOLLAS (\$1.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I, by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries (including the right to claim priority under the terms of the international Convention and other relevant international Treaties and Arrangements from the aforesaid application) and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.			
I hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignees of my entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me had this Assignment and sale not been made.			
Further, I agree that I will communicate to said ASSIGNEE or its (his) representatives any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.			
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.			
LEGAL NAME OF INVENTOR			
Inventor: Hiroaki ITO Date: Sep. 5. 2019			
Signature: Hiroaki Ito			

PATENT REEL: 050676 FRAME: 0691

Attorney Docket No. 1980H012U50 Client Docket No. 18-00117US01

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE

Invention SEMICONDUCTOR DEVICE			
As the below named inventor, I hereby declare that:			
This declaration 🔲 The attached application, or			
is directed to: United States application or PCT international application number 16/524,426 filed on July 29, 2019			
The above-identified application was made or authorized to be made by me.			
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.			
WHEREAS, ROHM Co., LTD.			
(hereinafter referred to as "ASSIGNEE") having places of business at: 21, Saiin Mizosaki-cho, Ukyo-ku, Kyoto-shi,			
Kyoto, Japan is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;			
NOW, THEREFORE, in consideration of the sum of ONE DOLLAS (\$1.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I, by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries (including the right to claim priority under the terms of the International Convention and other relevant International Treaties and Arrangements from the aforesaid application) and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.			
I hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignees of my entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me had this Assignment and sale not been made.			
Further, I agree that I will communicate to said ASSIGNEE or its (his) representatives any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.			
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both			
LEGAL NAME OF INVENTOR			
Inventor: Takanori OZAWA Date: Sep. 5, 20/9			
Signature: Takanori Ozawa			

PATENT REEL: 050676 FRAME: 0692

RECORDED: 10/10/2019